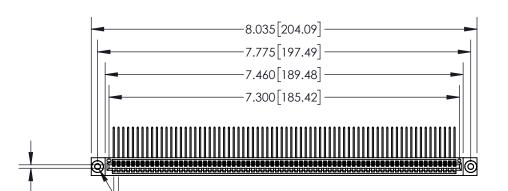
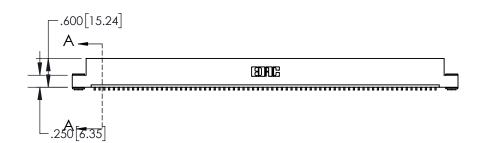
Contact Dimensions: 559-90 Degree Bend (Code 541 Contacts) See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions

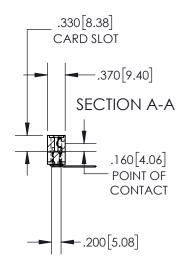




CARD SLOT ACCEPTS -.054" [1.37] TO .070"[1.78] THICK PCB

−2x Ø.156[3.96] —.100^[2.54]





- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
 - CONTACT MATERIAL; COPPER TIN ALLOY
 CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING
 ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SE	RIES HIGH TEMP	CARD	EDGE	CONNECTO	R
PART NUM	BFR: 845-072-55	9-103			

YOUR CONNECTION TO QUALITY & SERVICE

ACAD REFERENCE NO. 845-ENG-MASTER					
DRAWN: R.STA.MONICA	DATE:MAY.	16/2017			
CHECKED:	DATE:				
SCALE: 1:2	SHEET 1	OF 2			
DRAWING NUMBER		ISSUE			

845-ENG-MASTER







INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST

Contact Code 558

CONTACT MATERIAL; COPPER ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

Contact Code 559

	ACAD REFERENCE NO	. 845-ENG-MASTER
	DRAWN: R.STA.MONICA	DATE:MAY.16/2017
	CHECKED:	DATE:
	SCALE: 1:1	SHEET 2 OF 2
D	DRAWING NUMBER	ISSUE

Contact Code 560

845-ENG-MASTER